METAL-SEMICONDUCTING BEHAVIOR OF CARBON NANOTUBES ADSORBED ON HYDROGENATED Si(001) SURFACES

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The direct integration of CNTs into the well-established silicon technology may be an efficient alternative to achieve nanoscale devices and circuits in the near future. Recently, Albrecht and Lyding have demonstrated the feasibility to characterize single-walled CNTs adsorbed on H-passivated silicon surfaces using ultra-high vacuum scanning-tunneling microscopy (UHV-STM) techniques [1]. Following this way, the study of atomistic processes occurring at the CNT-surface interface and the effect of the substrate in the electronic properties of the adsorbed CNT, are important questions for the future realization of silicon-based nanoelectronics.

In this work, the adsorption of a metallic single-walled carbon nanotube (CNT) on hydrogenated Si(001) surfaces are studied from first-principles calculations. Our results indicate that the electronic properties of the adsorbed CNT can be ruled by the H concentration along the CNT-H/Si(001) contact region. On the fully hydrogenated Si(001), the CNT is physisorbed, preserving al-

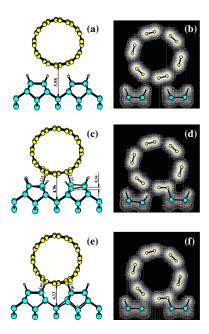


FIG. 1: Equilibrium geometries (left) and total charge densities contour plots (right), for the carbon nanotube adsorbed on the hydrogenated Si surfaces. The charge densities are depicted on a plane passes through the Si dimers. The numbers represent distances in Å.

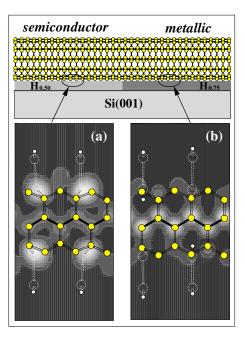


FIG. 2: (Top) Schematic representation of our proposed metal-semiconductor junction constructed with a single metallic CNT adsorbed on the surface trench of H/Si(001) with two different H concentrations. (Bottom) Charge density contour plots for the states just above the Fermi level

most unchanged its metallic character. Removing half the H atoms along the adsorption site, we find an enhancement on the metallicity of the adsorbed CNT. In contrast, removing all the H atoms along the adsorption site, the adsorbed CNT becomes semiconducting, exhibiting an energy gap. These results suggest that metallic CNTs adsorbed on H/Si(001) could be transformed into metal-semiconductor junctions by grading the H concentration along the CNT-surface interface.

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^[1] P.M. Albrecht and J.W. Lyding, Appl. Phys. Lett. 83, 5029 (2003).